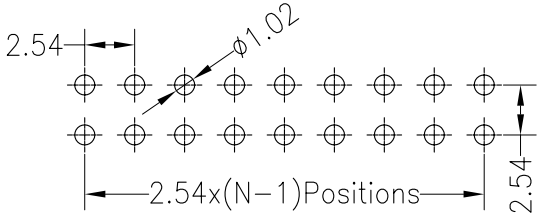
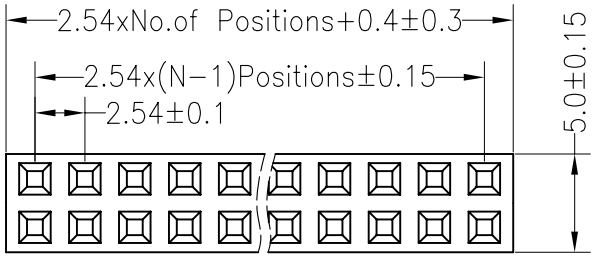
HSF RoHS FILE NO:E362810

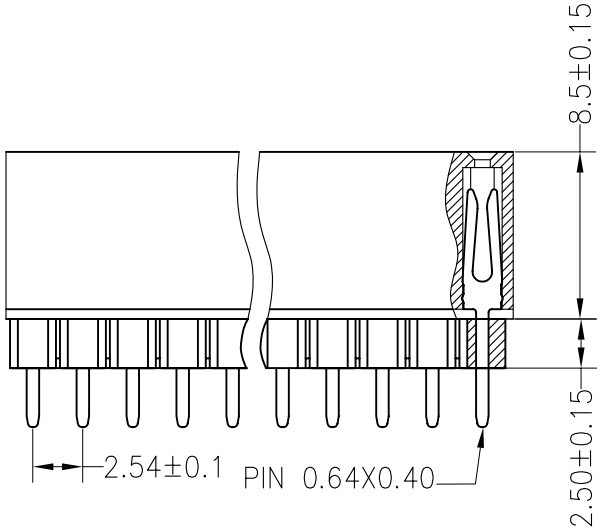
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

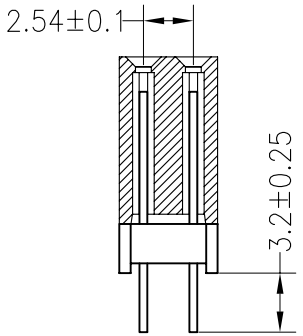
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PBT
Max.Processing Temp: 180°C for 30−60 seconds
(200°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)




## *Ordering Information*

2285D1 2 XX A N XX S Y T 02

| | | | |
|---|---|---|---|
| No.of Pins Per Row 1*40 | Insulator Material Option | Contact Plating | Packing |
| | A=BK−PBT | G1:1U" Gold | 0=PE Bag |
| | B=BK−PA66 | G2:1.5U" Gold | A=Tray |
| | C=BK−PA6T | G3:2U" Gold | T=Tube |
| | D=BK−PA46 | G4:3U" Gold | P=Tube+Cap |
| | F=BK−LCP | G5:5U" Gold | R=Reel+Cap |
| | | S0:Gold Flash/Tin | M=Reel+Mylar |
| | | SN:Tin | |

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| A0 | 2012.10.08 | NEW DRAWING | |

| OPERATION | | DRAW | Liu Miao | 12.10.08 |
|---|---|---|---|---|
| X.X | ±0.30 | | | |
| X.XX | ±0.20 | CHECK | | |
| X.XXX | ±0.10 | | | |
| Angle | ±3° | APPROVE | | |
| DIM | TOL | | | |

| | |
|---|---|
| SCALE | FIT |
| UNIT | mm |
| SIZE | A4 |
| SHEET | 1/1 |
| PROJ. | |

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

| | |
|---|---|
| PART NO. | 2285D12XXXNXXSYX01 |
| TITLE: | 2.54PF H8.5mm+H2.5mm 2xNpin 180° W5.0mm |